Infrared Emitter (940 nm) Version 1.3

SFH 4941C



Features:

- Wavelength 950nm
- Miniature package
- Short switching times
- · Same package dimensions as SFH 305

Applications

- · Miniature photointerrupters
- · Barcode reader
- Industrial electronics
- · For control and drive circuits
- Sensor technology
- Speed controller

Notes

Depending on the mode of operation, these devices emit highly concentrated non visible infrared light which can be hazardous to the human eye. Products which incorporate these devices have to follow the safety precautions given in IEC 60825-1 and IEC 62471.

Ordering Information

Туре:	Radiant Intensity	Ordering Code	
	I _e [mW/sr]		
	$I_F = 30 \text{ mA}, t_p = 20 \text{ ms}$		
SFH 4941C	30 (≥ 10)	Q65111A6124	

Note: measured at a solid angle of $\Omega = 0.001$ sr



$\underline{\text{Maximum Ratings } (T_A = 25 \, ^{\circ}\text{C})}$

Parameter	Symbol	Values	Unit
Operating temperature range	T _{op}	-40 80	°C
Storage temperature range	T _{stg}	-40 80	°C
Reverse voltage	V _R	5	٧
Forward current	I _F	30	mA
Surge current $(t_p \le 10 \ \mu s, D = 0)$	I _{FSM}	1	А
Power consumption	P _{tot}	50	mW
Thermal resistance junction - ambient	R _{thJA}	950	K/W
Thermal resistance junction - lead	R _{thJL}	850	K/W
ESD withstand voltage (acc. to ANSI/ ESDA/ JEDEC JS-001 - HBM)	V _{ESD}	2	kV

Characteristics $(T_A = 25 \, ^{\circ}C)$

Parameter		Symbol	Values	Unit
Peak wavelength $(I_F = 30 \text{ mA}, t_p = 20 \text{ ms})$	(typ)	λ_{peak}	950	nm
Centroid wavelength $(I_F = 30 \text{ mA}, t_p = 20 \text{ ms})$	(typ)	$\lambda_{centroid}$	940	nm
Spectral bandwidth at 50% of I_{max} ($I_F = 30 \text{ mA}$, $t_p = 20 \text{ ms}$)	(typ)	Δλ	42	nm
Half angle	(typ)	φ	± 10	0
Dimensions of active chip area	(typ)	LxW	0.3 x 0.3	mm x mm
Distance chip surface to lens top	(min max)	Н	1.3 1.9	mm
Rise and fall time of I_e (10% and 90% of $I_{e max}$) ($I_F = 30$ mA, $R_L = 50$ Ω)	(typ)	t _r , t _f	12	ns
Forward voltage $(I_F = 30 \text{ mA}, t_p = 20 \text{ ms})$	(typ (max))	V _F	1.3 (≤ 1.6)	V
Forward voltage (I _F = 1 A, t _p = 100 μs)	(typ (max))	V _F	3.6 (≤ 4.6)	V
Reverse current (V _R = 5 V)		I _R	not designed for reverse operation	μΑ
Total radiant flux (I _F =30 mA, t _p =20 ms)	(typ)	Фе	20	mW



Parameter		Symbol	Values	Unit
Temperature coefficient of I_e or Φ_e ($I_F = 30 \text{ mA}$, $t_p = 20 \text{ ms}$)	(typ)	TC _I	-0.3	% / K
Temperature coefficient of V_F ($I_F = 30 \text{ mA}, t_p = 20 \text{ ms}$)	(typ)	TC _V	-0.8	mV / K
Temperature coefficient of wavelength $(I_F = 30 \text{ mA}, t_p = 20 \text{ ms})$	(typ)	TC_λ	0.3	nm / K

Grouping ($T_A = 25$ °C)

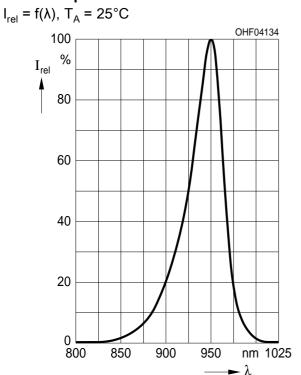
Group	Min Radiant Intensity	Max Radiant Intensity	Typ Radiant Intensity
	$I_F = 30 \text{ mA}, t_p = 20 \text{ ms}$	$I_F = 30 \text{ mA}, t_p = 20 \text{ ms}$	$I_F = 1 A, t_p = 10 \mu s$
	I _{e, min} [mW / sr]	I _{e, max} [mW/sr]	I _{e, typ} [mW / sr]
SFH 4941C-R	10	20	210
SFH 4941C-S	16	32	335
SFH 4941C-T	25	50	520
SFH 4941C-U	40	80	830

Note: measured at a solid angle of $\Omega = 0.001$ sr

Only one group in one packing unit (variation lower 2:1).

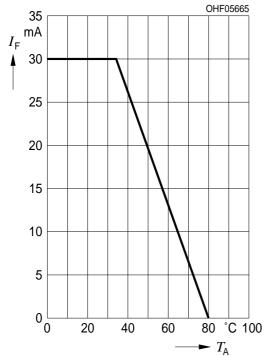


Relative Spectral Emission 1) page 9



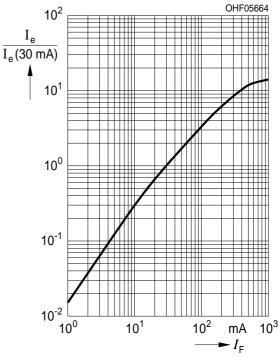
Max. Permissible Forward Current

$$I_{F, \text{max}} = f(T_A), R_{thJA} = 950 \text{ K / W}$$



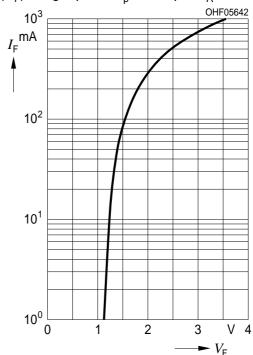
Radiant Intensity 1) page 9

 $I_e / I_e (30 \text{ mA}) = f(I_F)$, single pulse, $t_p = 100 \mu s$, $T_A = 25$ °C



Forward Current 1) page 9

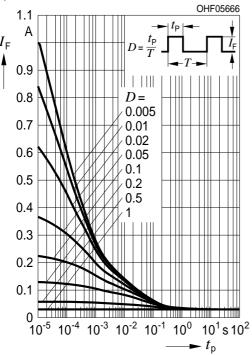
 $I_F = f(V_F)$, single pulse, $t_p = 100 \mu s$, $T_A = 25^{\circ} C$



Version 1.3

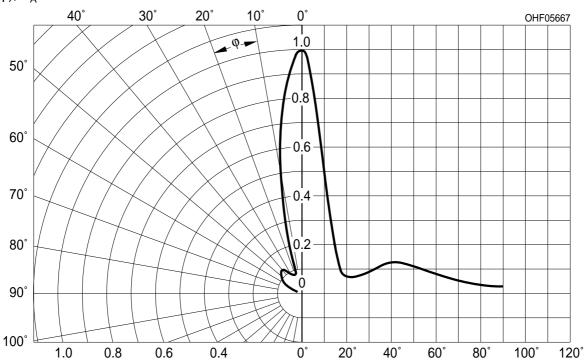
Permissible Pulse Handling Capability

 $I_F = f(t_p)$, $T_A = 25$ °C, duty cycle D = parameter

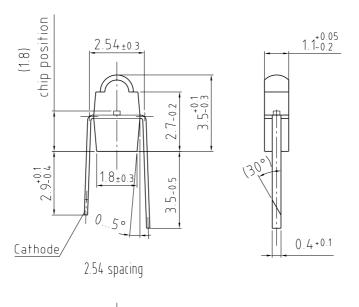


Radiation Characteristics 1) page 9

 $I_{rel} = f(\phi), T_A = 25^{\circ}C$



Package Outline



general tolerance ± 0.1

C63062-A4261-A1-01

Dimensions in mm.

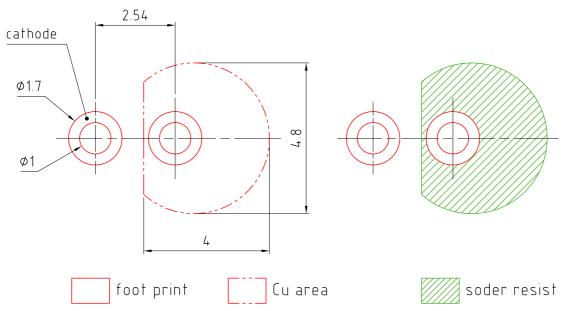
Package

Miniature Array, Epoxy

Approximate Weight:

14 mg

Recommended Solder Pad

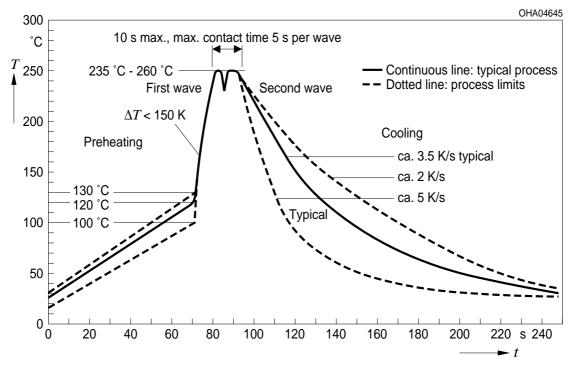


E062.3010.189-01

Dimensions in mm.

TTW Soldering

IEC-61760-1 TTW



Disclaimer

Language english will prevail in case of any discrepancies or deviations between the two language wordings.

Attention please!

The information describes the type of component and shall not be considered as assured characteristics.

Terms of delivery and rights to change design reserved. Due to technical requirements components may contain dangerous substances.

For information on the types in question please contact our Sales Organization.

If printed or downloaded, please find the latest version in the Internet.

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- **) Life support devices or systems are intended (a) to be implanted in the human body, or (b) to support and/or maintain and sustain human life. If they fail, it is reasonable to assume that the health and the life of the user may be endangered.



Glossary

Typical Values: Due to the special conditions of the manufacturing processes of LED, the typical data or calculated correlations of technical parameters can only reflect statistical figures. These do not necessarily correspond to the actual parameters of each single product, which could differ from the typical data and calculated correlations or the typical characteristic line. If requested, e.g. because of technical improvements, these typ. data will be changed without any further notice.



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